

## GenX3™ 600V IGBTs w/ Diode

## IXGA30N60C3D4 IXGP30N60C3D4

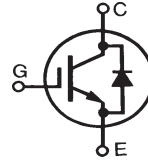
$$V_{CES} = 600V$$

$$I_{C110} = 30A$$

$$V_{CE(sat)} \leq 3.0V$$

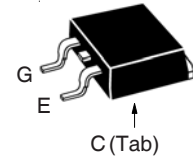
$$t_{fi(typ)} = 47ns$$

High-Speed PT IGBTs for  
40-100kHz Switching

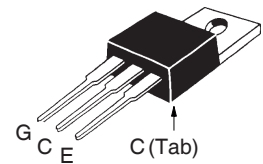


| Symbol                        | Test Conditions   | Maximum Ratings                   |            |
|-------------------------------|---|-----------------------------------|------------|
| $V_{CES}$                     | $T_C = 25^\circ C$ to $150^\circ C$   | 600                               | V          |
| $V_{CGR}$                     | $T_J = 25^\circ C$ to $150^\circ C$ , $R_{GE} = 1M\Omega$                           | 600                               | V          |
| $V_{GES}$                     | Continuous  | $\pm 20$                          | V          |
| $V_{GEM}$                     | Transient   | $\pm 30$                          | V          |
| $I_{C25}$                     | $T_C = 25^\circ C$  | 60                                | A          |
| $I_{C110}$                    | $T_C = 110^\circ C$   | 30                                | A          |
| $I_{CM}$                      | $T_C = 25^\circ C$ , 1ms  | 150                               | A          |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 125^\circ C$ , $R_G = 5\Omega$<br>Clamped Inductive Load | $I_{CM} = 60$<br>@ $\leq V_{CES}$ | A          |
| $P_C$                         | $T_C = 25^\circ C$  | 220                               | W          |
| $T_J$                         |   | -55 ... +150                      | $^\circ C$ |
| $T_{JM}$                      |   | 150                               | $^\circ C$ |
| $T_{stg}$                     |   | -55 ... +150                      | $^\circ C$ |
| $T_L$                         | 1.6mm (0.062 in.) from Case for 10s   | 300                               | $^\circ C$ |
| $T_{SOLD}$                    | Plastic Body for 10 seconds   | 260                               | $^\circ C$ |
| $M_d$                         | Mounting Torque (TO-220)  | 1.13/10                           | Nm/lb.in.  |
| <b>Weight</b>                 | TO-220  | 2.5                               | g          |
|                               | TO-263  | 3.0                               | g          |

TO-263 AA (IXGA)



TO-220AB (IXGP)



G = Gate      D = Collector  
S = Emitter    Tab = Collector

### Features

- Optimized for Low Switching Losses
- Square RBSOA
- Anti-Parallel Ultra Fast Diode
- International Standard Packages

### Advantages

- High Power Density
- Low Gate Drive Requirement

### Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- High Frequency Power Inverters

| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ Unless Otherwise Specified) | Characteristic Values |      |              |
|---------------|---|-----------------------|------|--------------|
|               |   | Min.                  | Typ. | Max.         |
| $BV_{CES}$    | $I_C = 250\mu A$ , $V_{GE} = 0V$                                    | 600                   |      | V            |
| $V_{GE(th)}$  | $I_C = 250\mu A$ , $V_{CE} = V_{GE}$                                | 4.0                   |      | 5.5 V        |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 125^\circ C$           |                       |      | 75 $\mu A$   |
|               |   |                       |      | 500 $\mu A$  |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                  |                       |      | $\pm 100$ nA |
| $V_{CE(sat)}$ | $I_C = 20A$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 125^\circ C$        | 2.6                   |      | 3.0 V        |
|               |   | 1.8                   |      | V            |

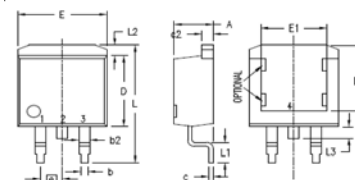
| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)   | Characteristic Values |      |                         |
|--------------|---|-----------------------|------|-------------------------|
|              |   | Min.                  | Typ. | Max.                    |
| $g_{fs}$     | $I_C = 20\text{A}, V_{CE} = 10\text{V}$ , Note 1  | 9                     | 16   | S                       |
| $C_{ies}$    | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$  |                       | 915  | pF                      |
| $C_{oes}$    |   |                       | 78   | pF                      |
| $C_{res}$    |   |                       | 32   | pF                      |
| $Q_g$        | $I_C = 20\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$   |                       | 38   | nC                      |
| $Q_{ge}$     |   |                       | 8    | nC                      |
| $Q_{gc}$     |   |                       | 17   | nC                      |
| $t_{d(on)}$  | <b>Inductive Load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = 20\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 300\text{V}, R_G = 5\Omega$  |                       | 16   | ns                      |
| $t_{ri}$     |   |                       | 26   | ns                      |
| $E_{on}$     |   |                       | 0.27 | mJ                      |
| $t_{d(off)}$ |   |                       | 42   | 75 ns                   |
| $t_{hi}$     |   |                       | 47   | ns                      |
| $E_{off}$    |   |                       | 0.09 | 0.18 mJ                 |
| $t_{d(on)}$  | <b>Inductive Load, <math>T_J = 125^\circ\text{C}</math></b><br>$I_C = 20\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 300\text{V}, R_G = 5\Omega$ |                       | 17   | ns                      |
| $t_{ri}$     |   |                       | 28   | ns                      |
| $E_{on}$     |   |                       | 0.44 | mJ                      |
| $t_{d(off)}$ |   |                       | 70   | ns                      |
| $t_{hi}$     |   |                       | 90   | ns                      |
| $E_{off}$    |   |                       | 0.33 | mJ                      |
| $R_{thJC}$   |   |                       |      | 0.56 $^\circ\text{C/W}$ |
| $R_{thCS}$   | TO-220  | 0.50                  |      | $^\circ\text{C/W}$      |

### Reverse Diode (FRED)

| Symbol     | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)   | Characteristic Values     |      |                        |   |
|------------|---|---------------------------|------|------------------------|---|
|            |   | Min.                      | Typ. | Max.                   |   |
| $V_F$      | $I_F = 10\text{A}, V_{GE} = 0\text{V}$ , Note 1<br>$T_J = 150^\circ\text{C}$  |                           | 1.7  | 3.0 V                  |   |
| $t_{rr}$   | $I_F = 10\text{A}, -di_F/dt = 200\text{A}/\mu\text{s}$<br>$V_R = 300\text{V}$ | $T_J = 100^\circ\text{C}$ | 60   | ns                     |   |
| $I_{RM}$   |   | $T_J = 25^\circ\text{C}$  |      | 3                      | A |
|            |   | $T_J = 100^\circ\text{C}$ |      | 4                      | A |
| $R_{thJC}$ |   |                           |      | 2.5 $^\circ\text{C/W}$ |   |

Note 1: Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .

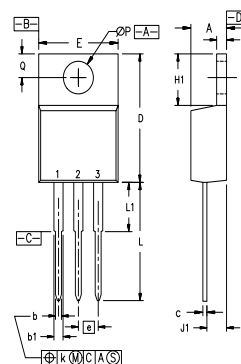
### TO-263 Outline



- 1 = Gate
- 2 = Collector
- 3 = Emitter
- 4 = Collector

| SYM | INCHES   |      | MILLIMETERS |       |
|-----|----------|------|-------------|-------|
|     | MIN      | MAX  | MIN         | MAX   |
| A   | .160     | .190 | 4.06        | 4.83  |
| A1  | .080     | .110 | 2.03        | 2.79  |
| b   | .020     | .039 | 0.51        | 0.99  |
| b2  | .045     | .055 | 1.14        | 1.40  |
| c   | .016     | .029 | 0.40        | 0.74  |
| c2  | .045     | .055 | 1.14        | 1.40  |
| D   | .340     | .380 | 8.64        | 9.65  |
| D1  | .315     | .350 | 8.00        | 8.89  |
| E   | .380     | .410 | 9.65        | 10.41 |
| E1  | .245     | .320 | 6.22        | 8.13  |
| e   | .100 BSC |      | 2.54 BSC    |       |
| L   | .575     | .625 | 14.61       | 15.88 |
| L1  | .090     | .110 | 2.29        | 2.79  |
| L2  | .040     | .055 | 1.02        | 1.40  |
| L3  | .050     | .070 | 1.27        | 1.78  |
| L4  | 0        | .005 | 0           | 0.13  |

### TO-220 Outline



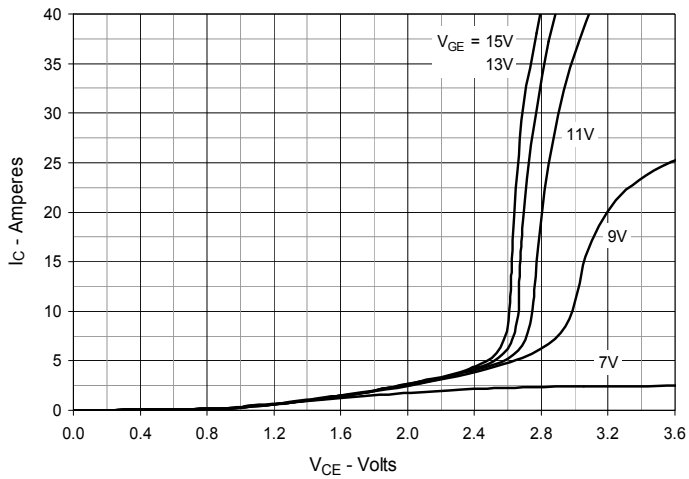
- 1 = Gate
- 2 = Collector
- 3 = Emitter

| SYM | INCHES   |      | MILLIMETERS |       |
|-----|----------|------|-------------|-------|
|     | MIN      | MAX  | MIN         | MAX   |
| A   | .170     | .190 | 4.32        | 4.83  |
| b   | .025     | .040 | 0.64        | 1.02  |
| b1  | .045     | .065 | 1.15        | 1.65  |
| c   | .014     | .022 | 0.35        | 0.56  |
| D   | .580     | .630 | 14.73       | 16.00 |
| E   | .390     | .420 | 9.91        | 10.66 |
| e   | .100 BSC |      | 2.54 BSC    |       |
| F   | .045     | .055 | 1.14        | 1.40  |
| H1  | .230     | .270 | 5.85        | 6.85  |
| J1  | .090     | .110 | 2.29        | 2.79  |
| k   | 0        | .015 | 0           | 0.38  |
| L   | .500     | .550 | 12.70       | 13.97 |
| L1  | .110     | .230 | 2.79        | 5.84  |
| ØP  | .139     | .161 | 3.53        | 4.08  |
| Q   | .100     | .125 | 2.54        | 3.18  |

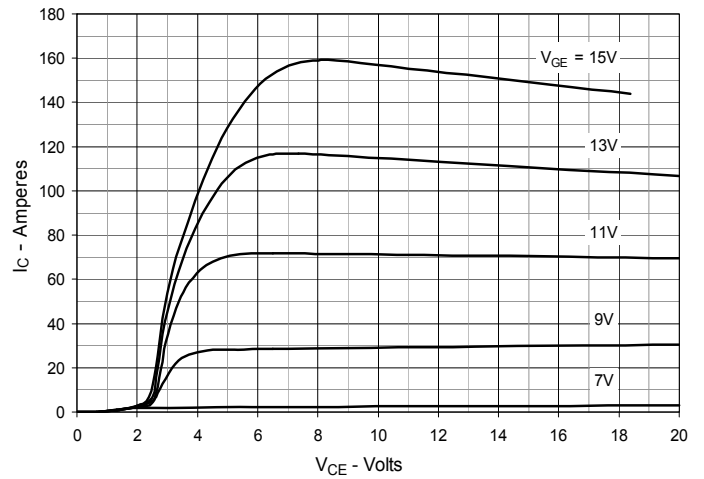
IXYS Reserves the Right to Change Limits, Test Conditions and Dimensions.

|  |           |           |           |           |              |              |              |              |              |              |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|--------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338 B2 |
|  | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |              |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |              |

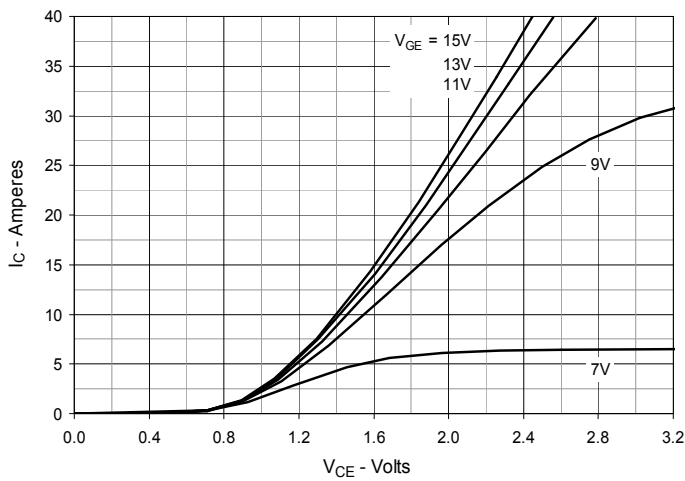
**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$**



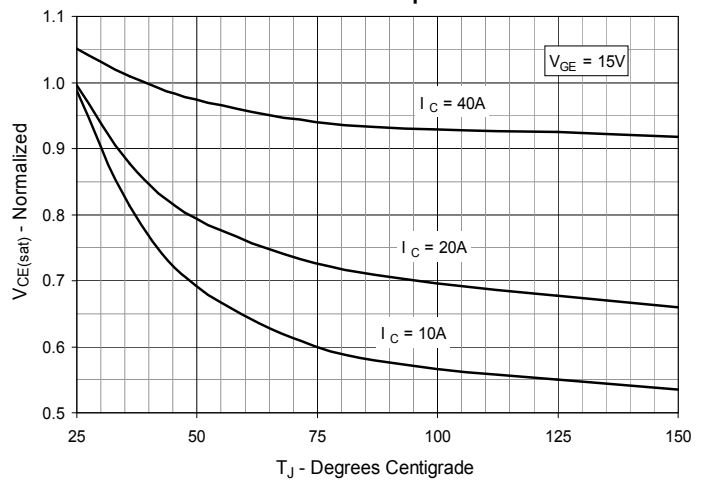
**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$**



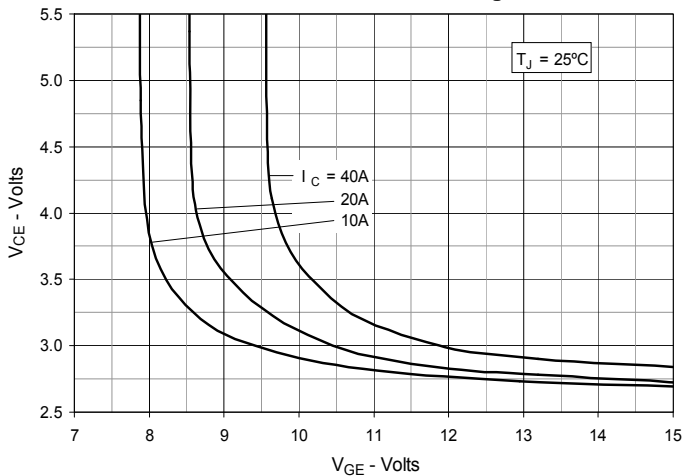
**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$**



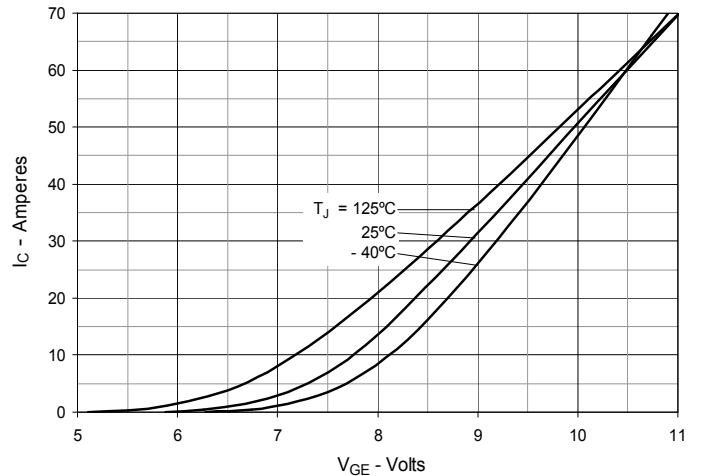
**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**



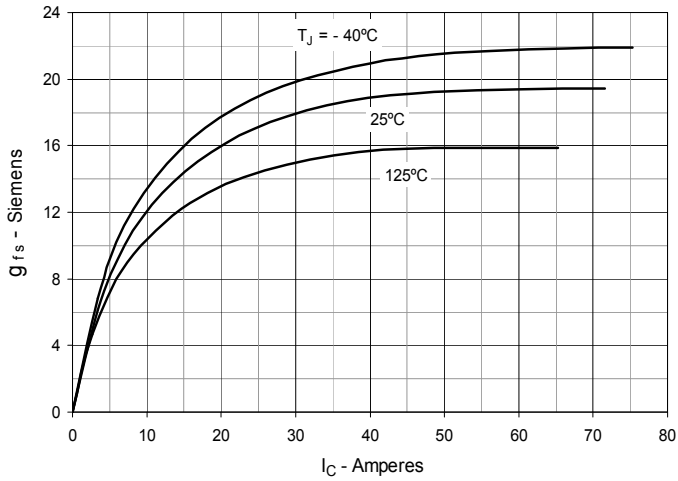
**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



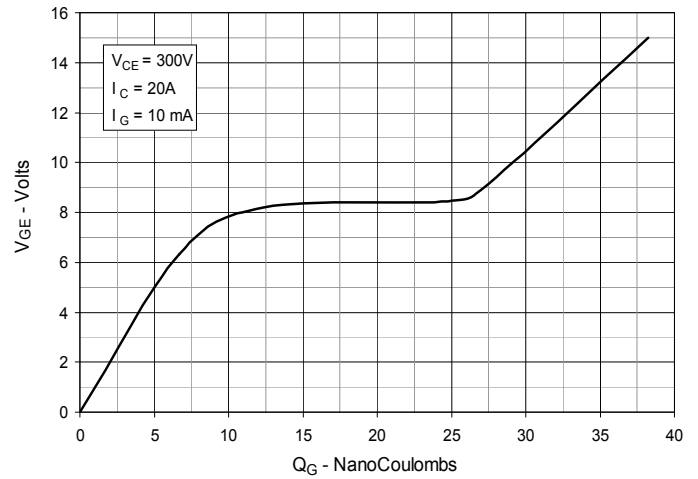
**Fig. 6. Input Admittance**



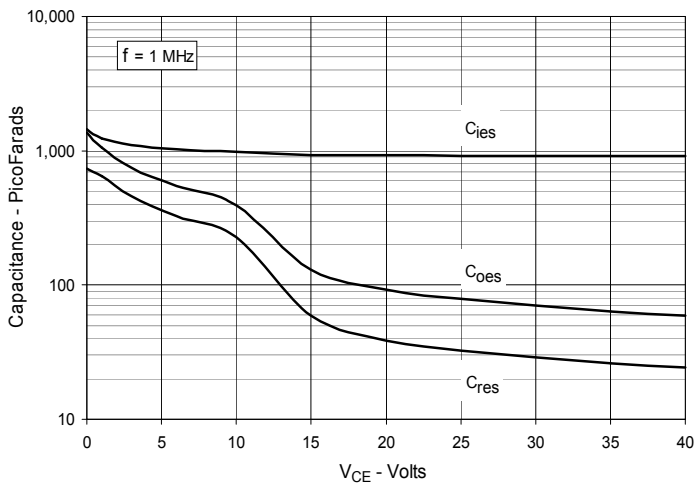
**Fig. 7. Transconductance**



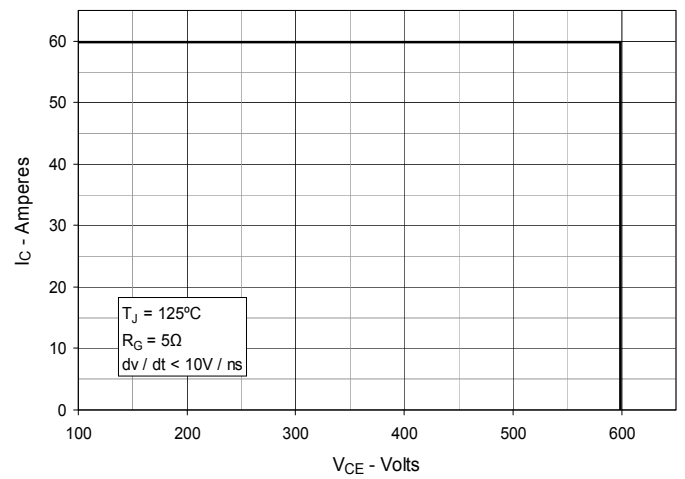
**Fig. 8. Gate Charge**



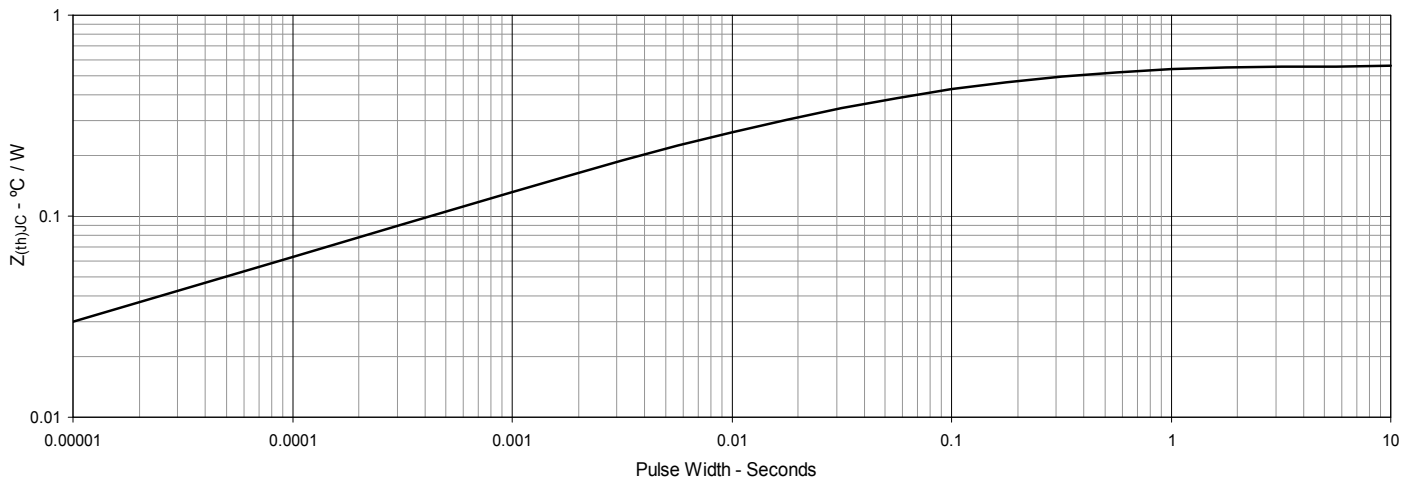
**Fig. 9. Capacitance**



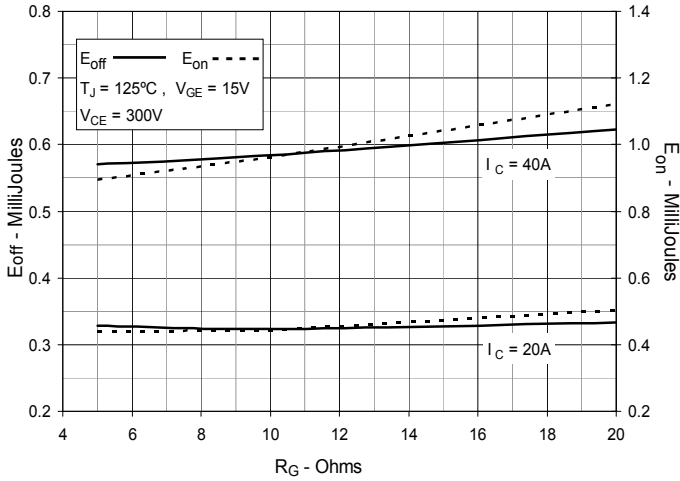
**Fig. 10. Reverse-Bias Safe Operating Area**



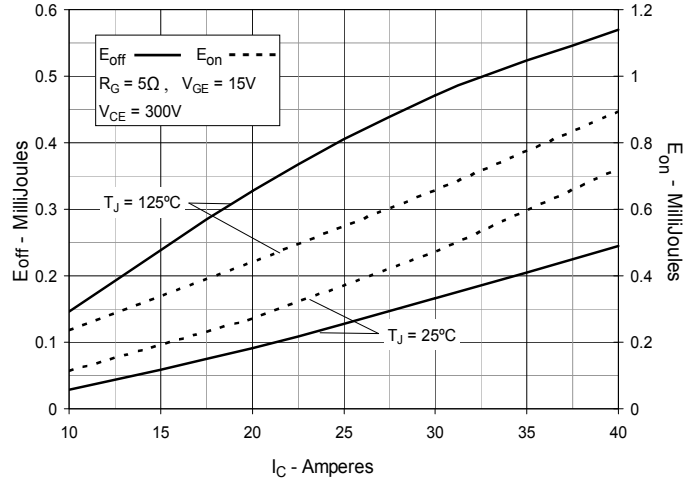
**Fig. 11. Maximum Transient Thermal Impedance**



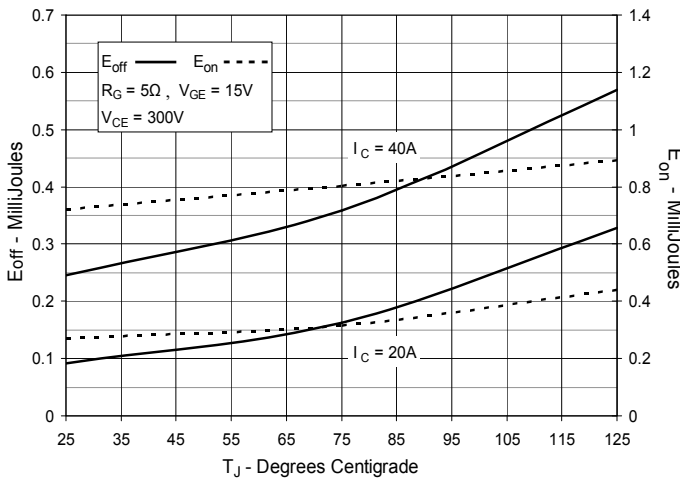
**Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance**



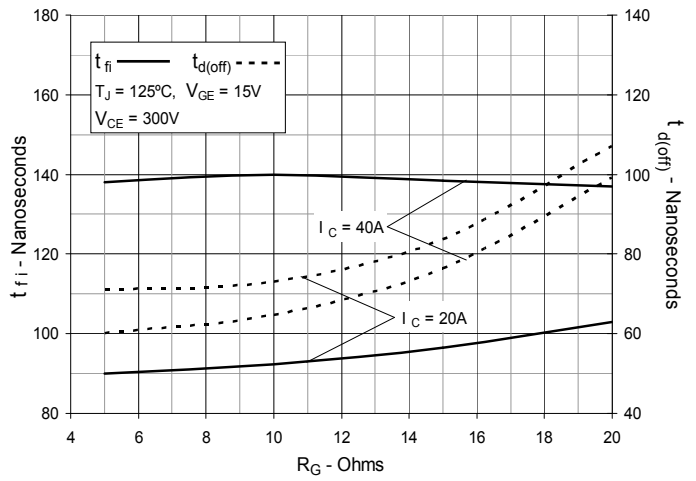
**Fig. 13. Inductive Switching Energy Loss vs. Collector Current**



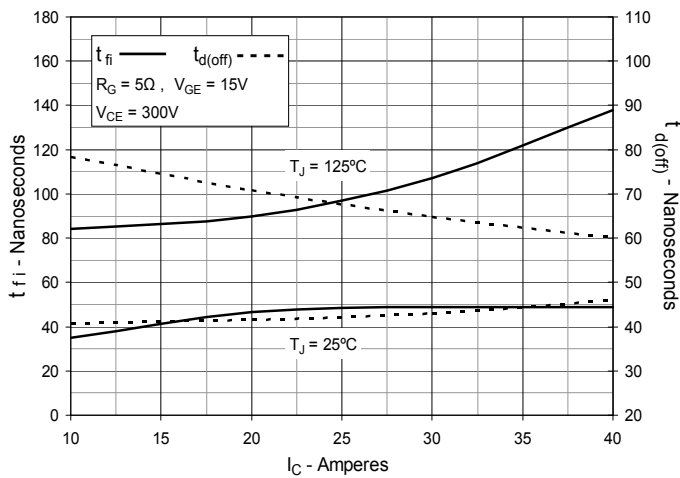
**Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature**



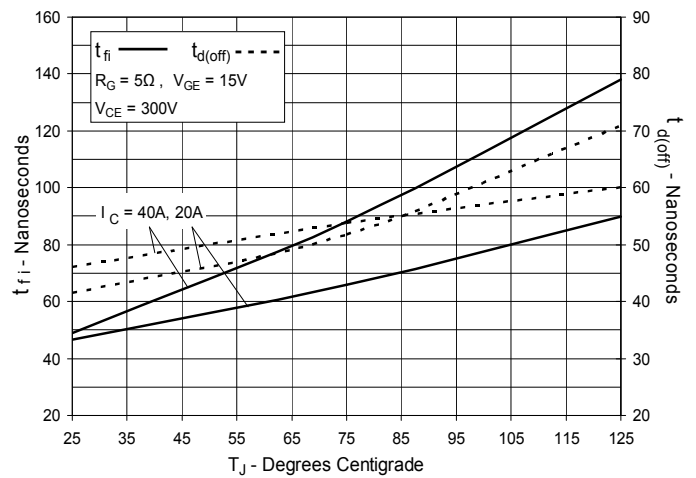
**Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance**



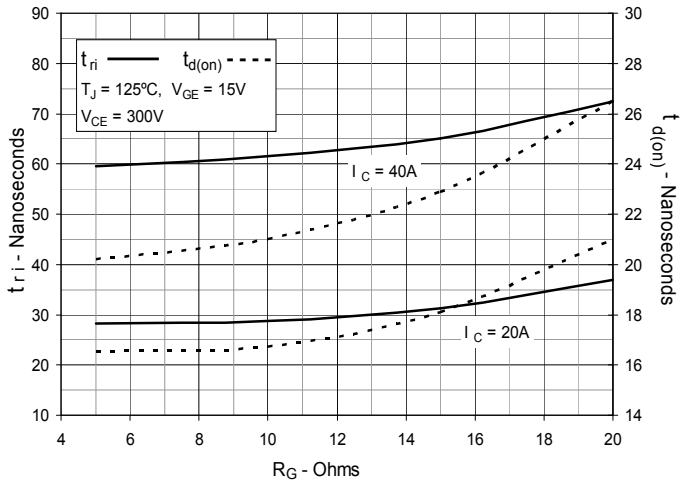
**Fig. 16. Inductive Turn-off Switching Times vs. Collector Current**



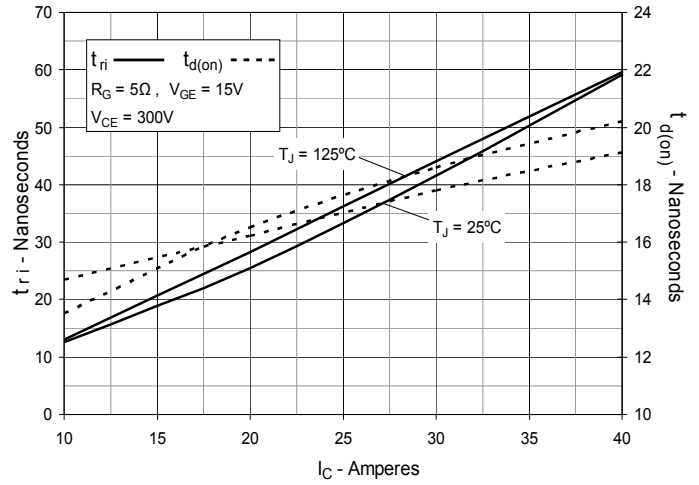
**Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature**



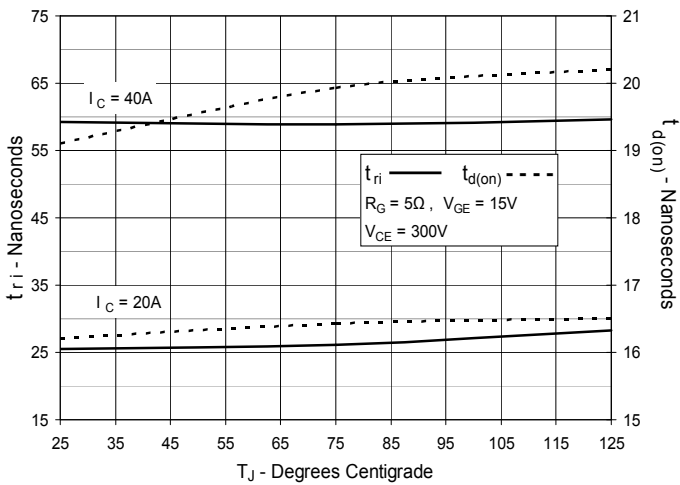
**Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance**



**Fig. 19. Inductive Turn-on Switching Times vs. Collector Current**



**Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature**



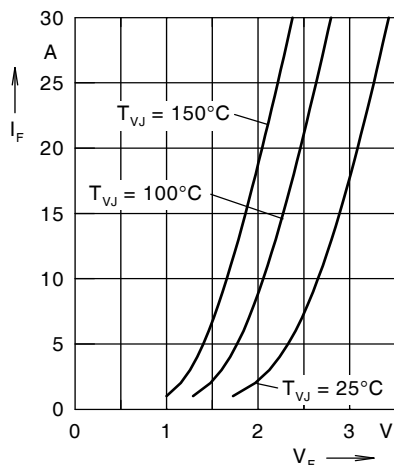


Fig. 21. Forward current  $I_F$  versus  $V_F$

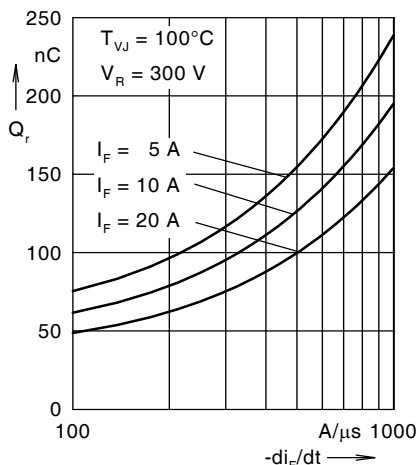


Fig. 22. Reverse recovery charge  $Q_r$

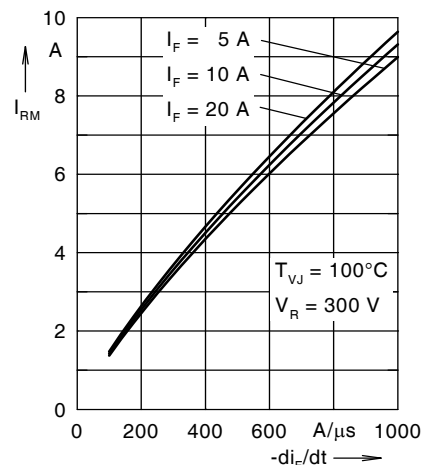


Fig. 23. Peak reverse current  $I_{RM}$

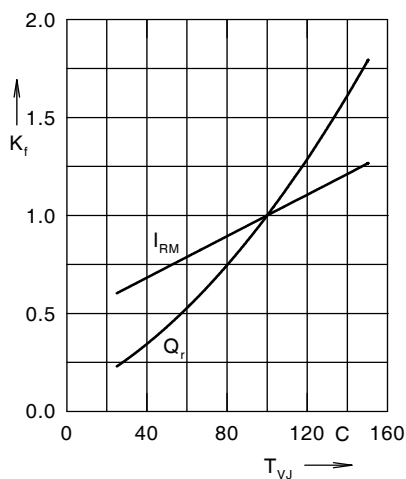


Fig. 24. Dynamic parameters  $Q_r$ ,  $I_{RM}$

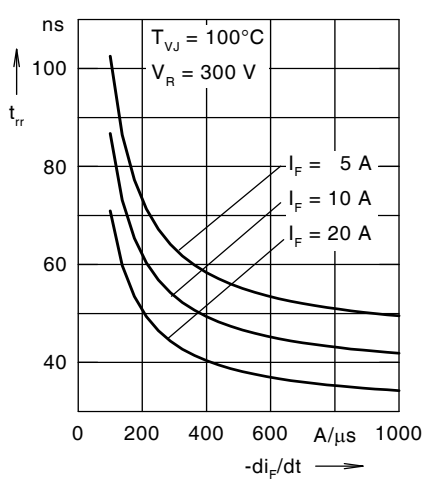


Fig. 25. Recovery time  $t_{rr}$  versus  $-di_F/dt$

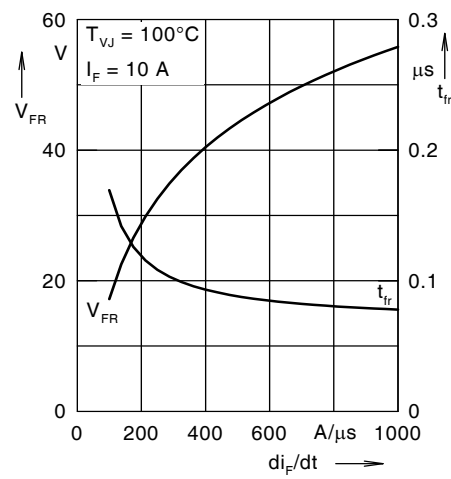


Fig. 26. Peak forward voltage  $V_{FR}$  and  $t_{rr}$

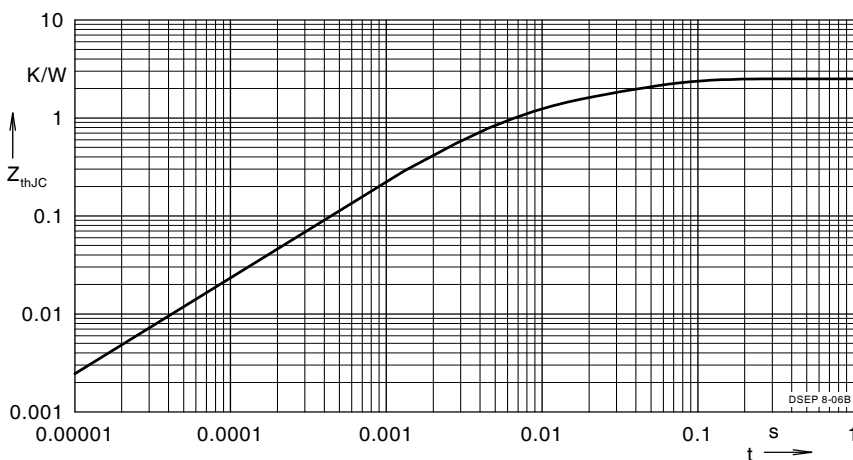


Fig. 27. Transient thermal resistance junction-to-case

NOTE: Fig. 2 to Fig. 6 shows typical values

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренеспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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